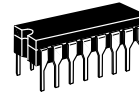


Quad TTL-to-MECL Translator With TTL Strobe Input

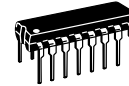
The MC10H124 is a quad translator for interfacing data and control signals between a saturated logic section and the MECL section of digital systems. The 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in propagation delay, and no increase in power-supply current.

- Propagation Delay, 1.5 ns Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible

MC10H124



L SUFFIX
CERAMIC PACKAGE
CASE 620-10



P SUFFIX
PLASTIC PACKAGE
CASE 648-08



FN SUFFIX
PLCC
CASE 775-02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply ($V_{CC} = 5.0\text{ V}$)	V_{EE}	-8.0 to 0	Vdc
Power Supply ($V_{EE} = -5.2\text{ V}$)	V_{CC}	0 to +7.0	Vdc
Input Voltage ($V_{CC} = 5.0\text{ V}$) TTL	V_I	0 to V_{CC}	Vdc
Output Current — Continuous	I_{out}	50	mA
— Surge		100	
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic	T_{stg}	-55 to +150	°C
— Ceramic		-55 to +165	

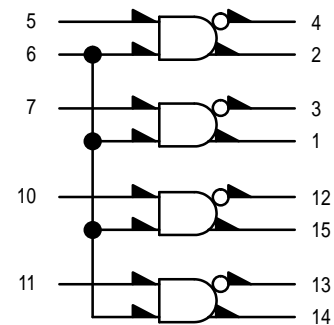
ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2\text{ V} \pm 5\%$, $V_{CC} = 5.0\text{ V} \pm 5.0\%$)

Characteristic	Symbol	0°		25°		75°		Unit	
		Min	Max	Min	Max	Min	Max		
Negative Power Supply Drain Current	I_E	—	72	—	66	—	72	mA	
Positive Power Supply Drain Current	I_{CCH}	—	16	—	16	—	18	mA	
	I_{CCL}	—	25	—	25	—	25	mA	
Reverse Current	I_R	Pin 6	—	200	—	200	—	200	μA
		Pin 7	—	50	—	50	—	50	
Forward Current	I_F	Pin 6	—	-12.8	—	-12.8	—	-12.8	mA
		Pin 7	—	-3.2	—	-3.2	—	-3.2	
Input Breakdown Voltage	$V_{(BR)in}$	5.5	—	5.5	—	5.5	—	Vdc	
Input Clamp Voltage	V_I	—	-1.5	—	-1.5	—	-1.5	Vdc	
High Output Voltage	V_{OH}	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc	
Low Output Voltage	V_{OL}	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc	
High Input Voltage	V_{IH}	2.0	—	2.0	—	2.0	—	Vdc	
Low Input Voltage	V_{IL}	—	0.8	—	0.8	—	0.8	Vdc	

NOTE:

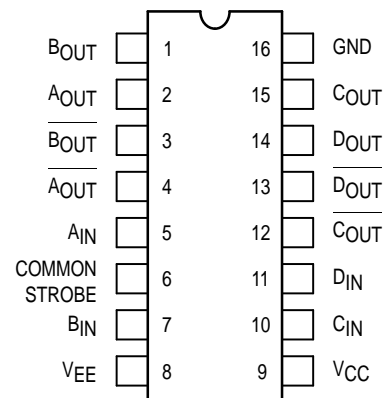
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

LOGIC DIAGRAM



GND = PIN 16
 V_{CC} (+5.0 VDC) = PIN 9
 V_{EE} (-5.2 VDC) = PIN 8

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-36 of the Motorola MECL Data Book (DL122/D).



ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 \text{ V} \pm 5\%$, $V_{CC} = 5.0 \text{ V} \pm 5.0\%$)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	

AC PARAMETERS

Propagation Delay	t_{pd}	0.55	2.25	0.55	2.4	0.85	2.95	ns
Rise Time	t_r	0.5	1.5	0.5	1.6	0.5	1.7	ns
Fall Time	t_f	0.5	1.5	0.5	1.6	0.5	1.7	ns

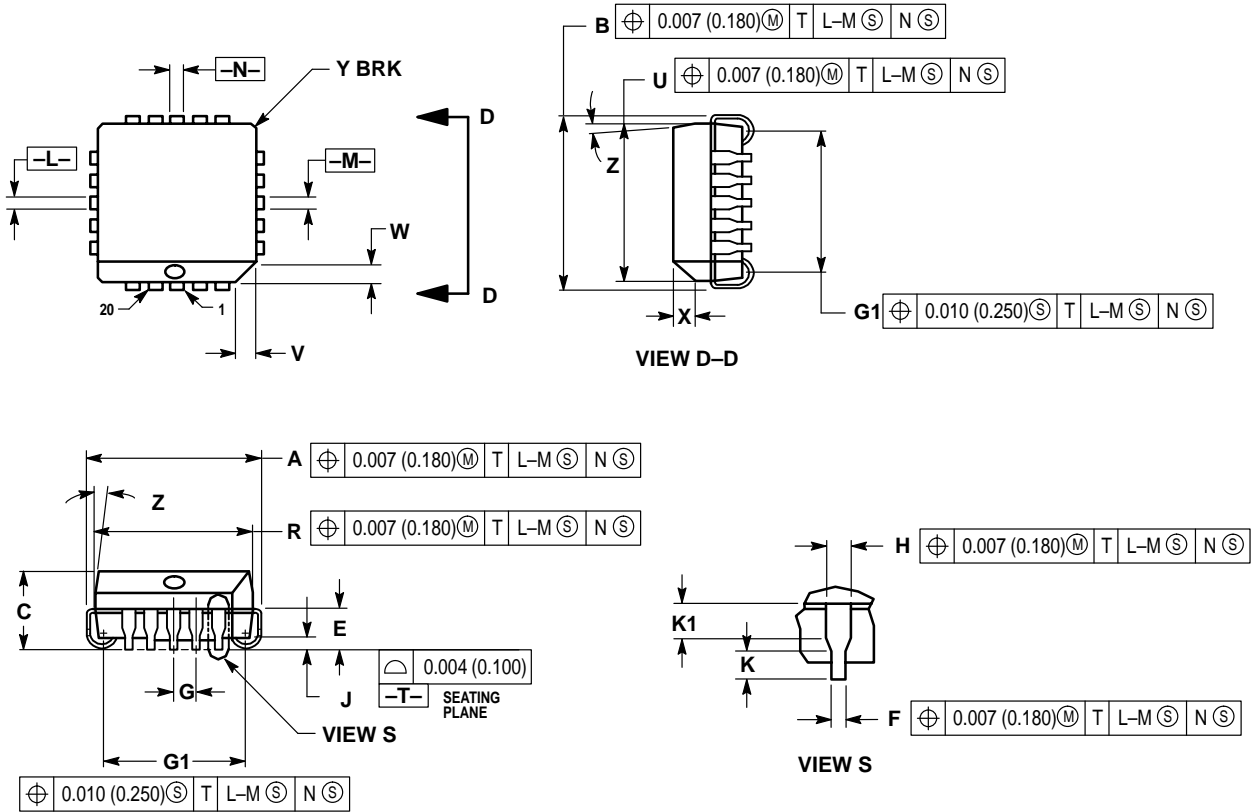
APPLICATIONS INFORMATION

The MC10H124 has TTL-compatible inputs and MECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at the low-logic level, it forces all true outputs to a MECL low-logic state and all inverting outputs to a MECL high-logic state.

An advantage of this device is that TTL-level information can be transmitted differentially, via balanced twisted pair lines, to MECL equipment, where the signal can be received by the MC10H115 or MC10H116 differential line receivers. The power supply requirements are ground, +5.0 volts, and -5.2 volts.

OUTLINE DIMENSIONS

FN SUFFIX
 PLASTIC PLCC PACKAGE
 CASE 775-02
 ISSUE C

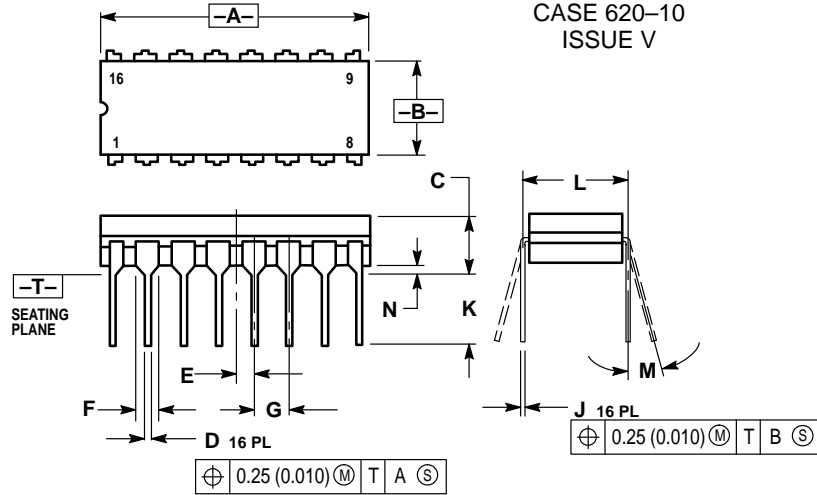


- NOTES:
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
 - DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
 - DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
 - DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: INCH.
 - THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
 - DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

OUTLINE DIMENSIONS

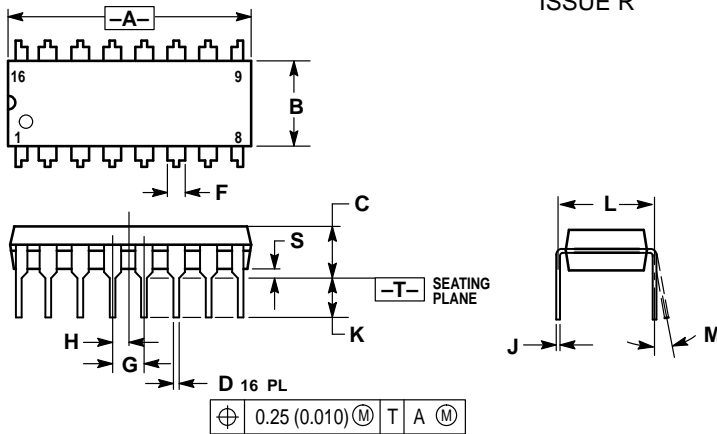
L SUFFIX
CERAMIC DIP PACKAGE
CASE 620-10
ISSUE V



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

P SUFFIX
PLASTIC DIP PACKAGE
CASE 648-08
ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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